

Docket No.: 065933-0084



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Ryosuke USUI, et al.

Application No.: 10/813,629

Filed: March 31, 2004

Customer Number: 20277

Confirmation Number: 3812

Group Art Unit: 2814

Examiner: Dilinh P. Nguyen

For: SEMICONDUCTOR MODULE AND METHOD OF MANUFACTURING THE SAME

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Transmitted herewith is an Amendment in the above-identified application.

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No additional fee is required.

Applicant is entitled to small entity status under 37 CFR 1.27

Also attached:

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	26	22	4	\$50.00 =	\$200.00
Independent Claims	7	5	2	\$200.00 =	\$400.00
Multiple dependent claims newly presented					\$0.00
Fee for extension of time					\$0.00
					\$0.00
Total of Above Calculations					\$600.00

- ☒ Please charge my Deposit Account No. 500417 in the amount of \$600.00. An additional copy of this transmittal sheet is submitted herewith.
- ☒ The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 500417, including any filing fees under 37 CFR 1.16 for presentation of extra claims and any patent application processing fees under 37 CFR 1.17.

Respectfully submitted,

McDERMOTT WILL & EMERY LLP

Tomoki Tanida

Limited Recognition No. L0098

Please recognize our Customer No. 20277 as our
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Date: March 19, 2007
WDC99 1364154-1.065933.0084